

TO-252 Pin Configuration

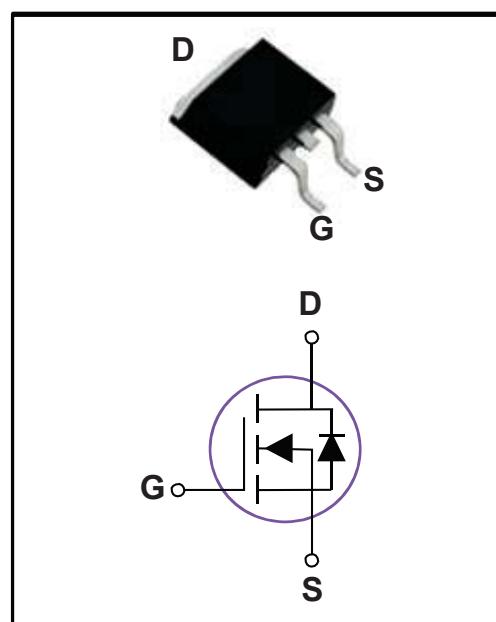
BVDSS	RDS(ON)	ID
200V	0.240	9A

Features

- 200V, 9A, $R_{DS(ON)} = 0.24\Omega$ @ $V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

Applications

- Networking
- Load Switch
- LED applications


MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current – Continuous ($T_c=25^\circ C$)	I_D	9	A
Drain Current – Continuous ($T_c=100^\circ C$)		5.7	A
Drain Current – Pulsed ¹	I_{DM}	36	A
Single Pulse Avalanche Energy ²	E_{AS}	220	mJ
Single Pulse Avalanche Current ²	I_{AS}	21	A
Power Dissipation ($T_c=25^\circ C$)	P_D	44	W
Power Dissipation – Derate above 25 °C		0.35	W/°C
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction to ambient	$R_{\theta JA}$	---	62	°C/W
Thermal Resistance Junction to Case	$R_{\theta JC}$	---	2.87	°C/W

MOSFET ELECTRICAL CHARACTERISTICS $T_A = 25^\circ C$ unless otherwise specified

Off Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	200	---	---	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=200V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	μA
		$V_{DS}=160V, V_{GS}=0V, T_J=125^\circ C$	---	---	10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA

On Characteristics

Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=4A$	---	0.2	0.24	Ω
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1	2	3	V
Forward Transconductance	g_{fs}	$V_{DS}=30V, I_D=3A$	---	4	---	S

Dynamic and switching Characteristics

Total Gate Charge ^{3, 4}	Q_g	$V_{DS}=100V, V_{GS}=10V, I_D=5A$	---	12	18	nC
Gate-Source Charge ^{3, 4}	Q_{gs}		---	1	3	
Gate-Drain Charge ^{3, 4}	Q_{gd}		---	5	8	
Turn-On Delay Time ^{3, 4}	$T_{d(on)}$	$V_{DD}=100V, V_{GS}=10V, R_G=60 \Omega, I_D=5A$	---	5	9	ns
Rise Time ^{3, 4}	T_r		---	17.4	33	
Turn-Off Delay Time ^{3, 4}	$T_{d(off)}$		---	40.7	80	
Fall Time ^{3, 4}	T_f		---	11.4	23	
Input Capacitance	C_{iss}		---	540	810	pF
Output Capacitance	C_{oss}	$V_{DS}=100V, V_{GS}=0V, F=1MHz$	---	48	72	
Reverse Transfer Capacitance	C_{rss}		---	11	17	
Gate resistance	R_g	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	---	2.6	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_s	$V_G=V_D=0V$, Force Current	---	---	9	A
Pulsed Source Current	I_{SM}		---	---	18	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_s=1A, T_J=25^\circ C$	---	---	1	V
Reverse Recovery Time	t_{rr}	$V_R=200V, I_s=5A$ $di/dt=100A/\mu s, T_J=25^\circ C$	---	130	---	ns
	Q_{rr}		---	520	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=50V, V_{GS}=10V, L=1mH, I_{AS}=21A, R_G=25\Omega$, Starting $T_J=25^\circ C$.
3. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

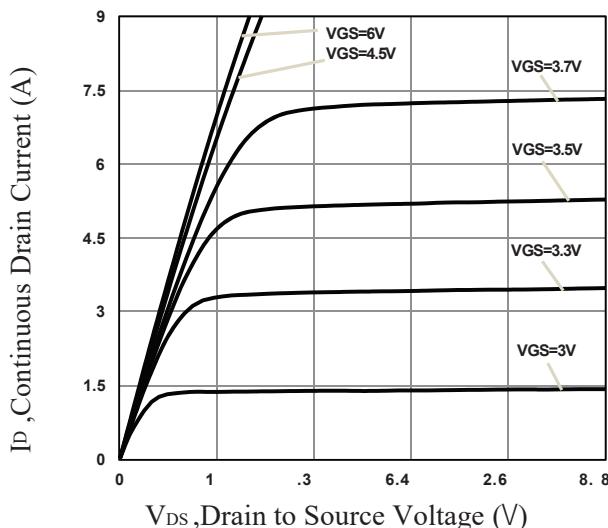


Fig.1 Typical Output Characteristics

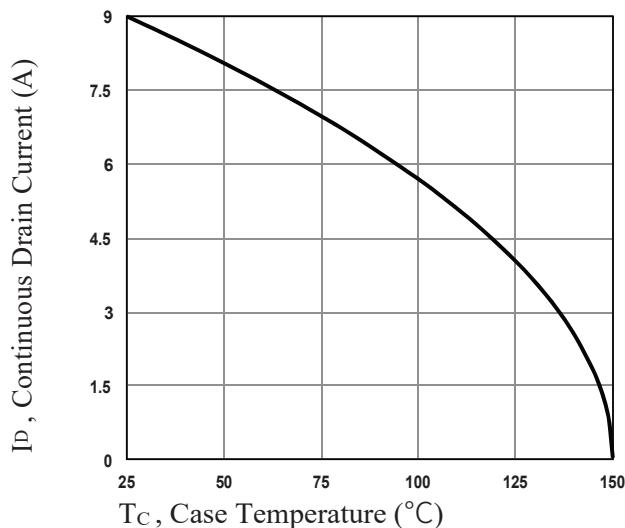


Fig.2 Continuous Drain Current vs. T_c

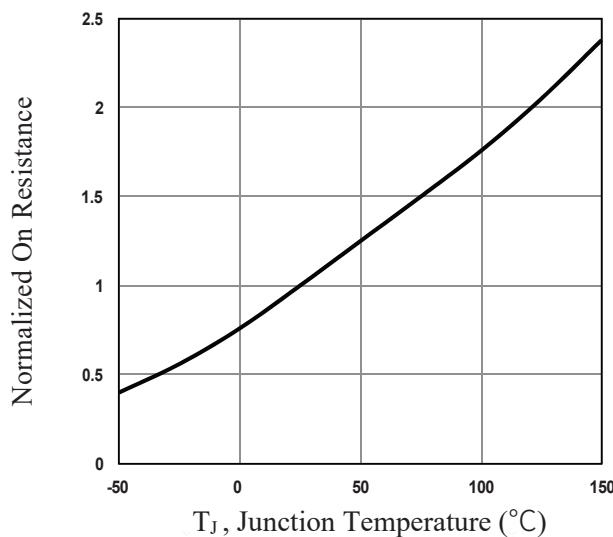


Fig.3 Normalized R_{DSON} vs. T_j

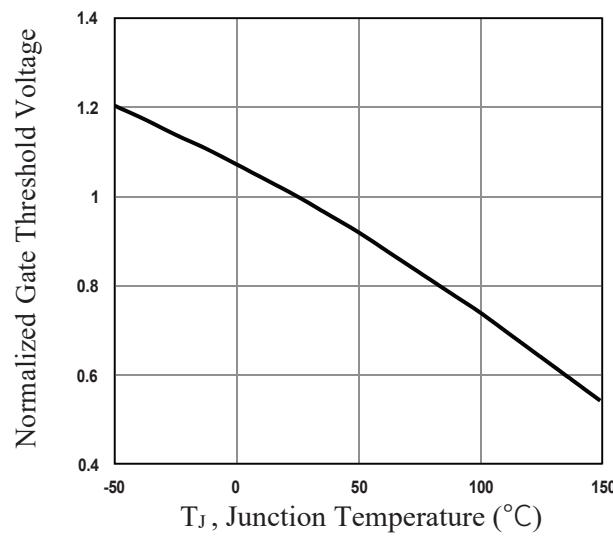


Fig.4 Normalized V_{th} vs. T_j

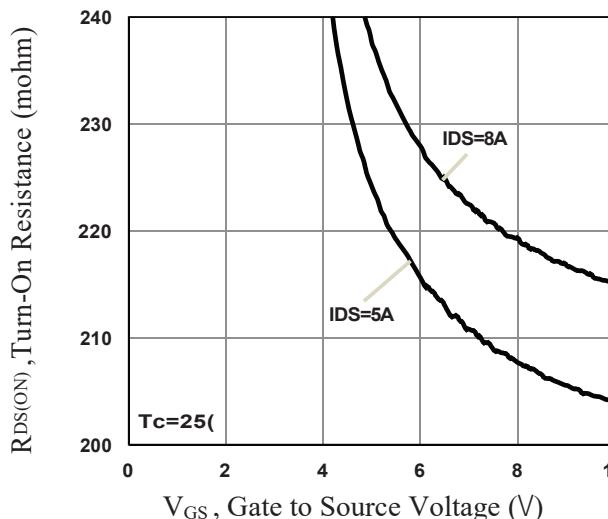


Fig.5 Turn-On Resistance vs. V_{GS}

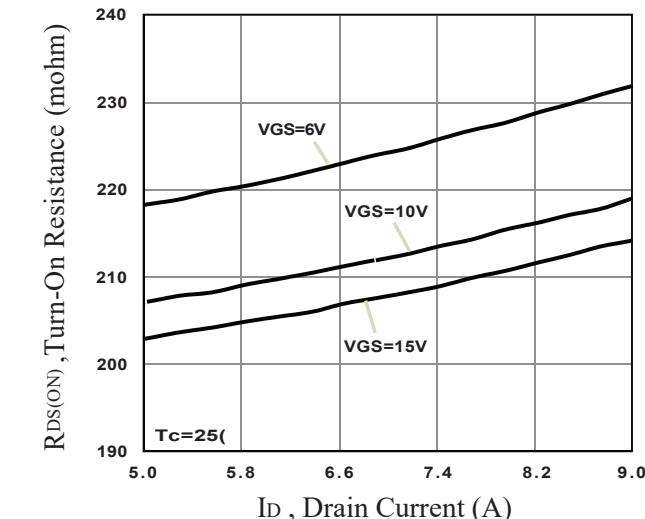
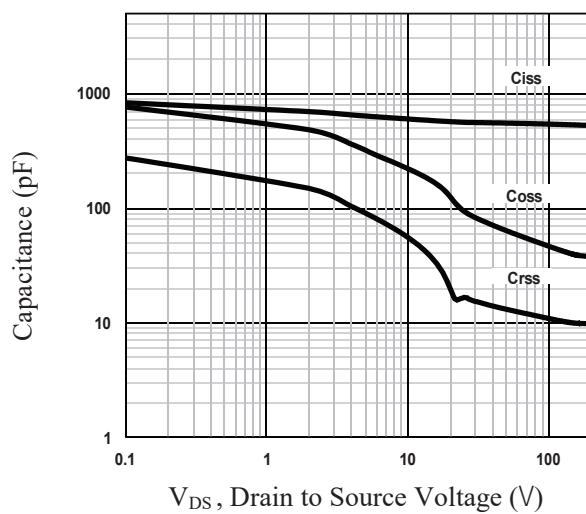
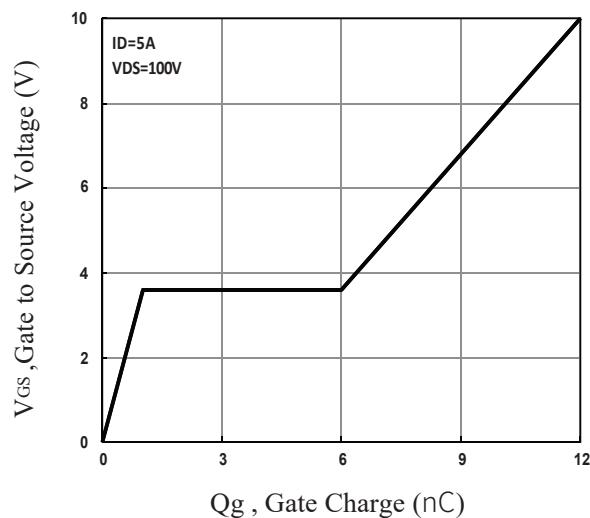
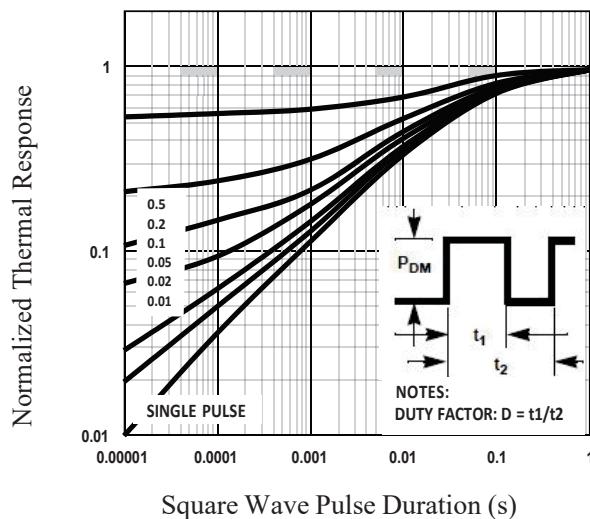
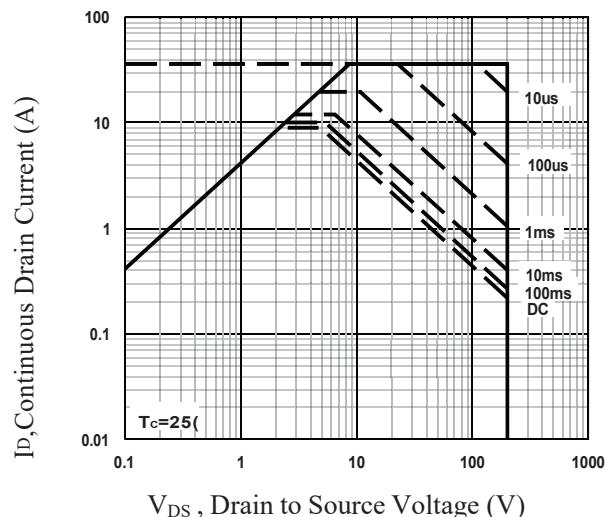
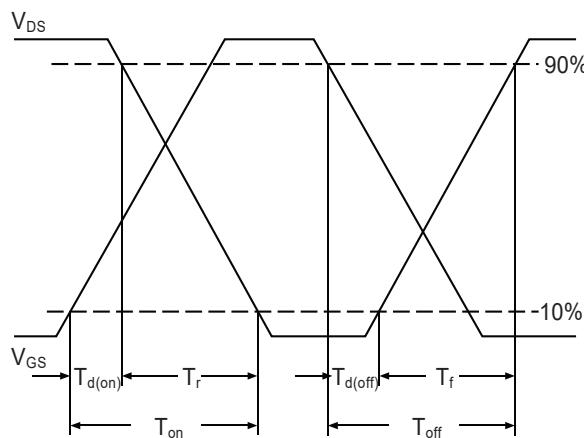
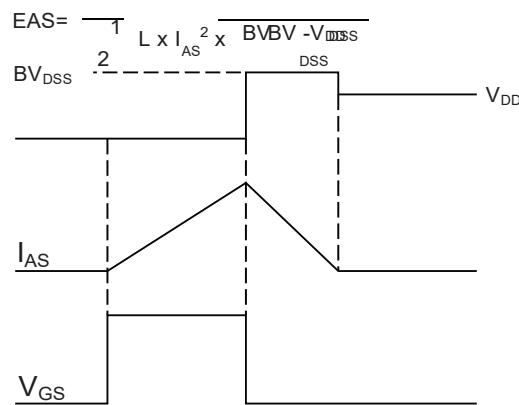
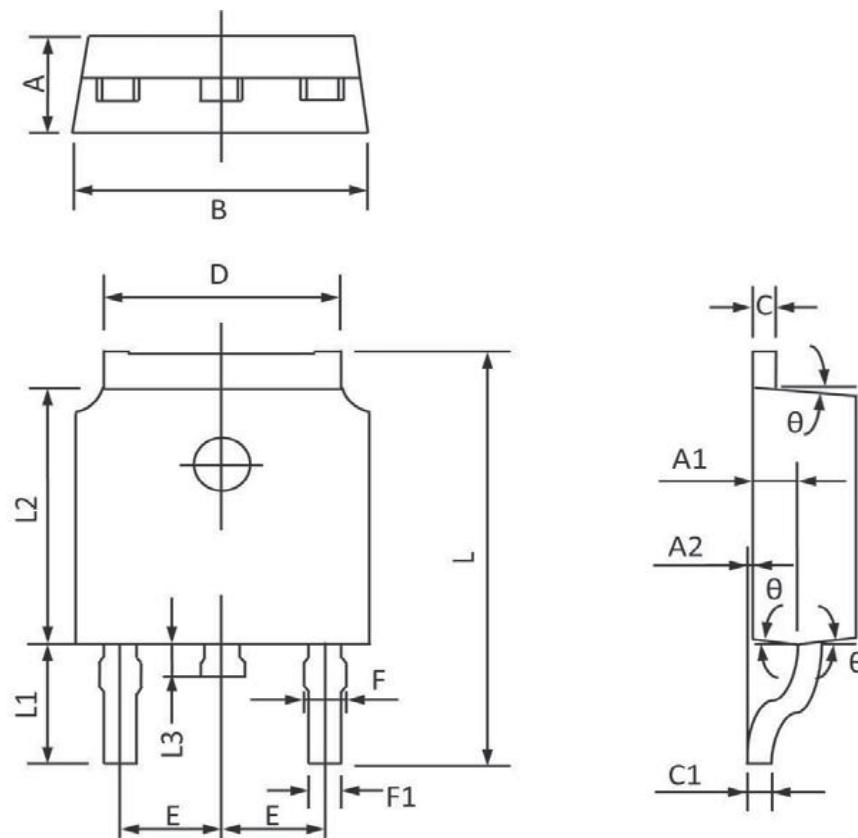


Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 EAS Waveform

TO-252 PACKAGE INFORMATION


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.450	2.150	0.096	0.085
A1	1.200	0.910	0.047	0.036
A2	0.150	0.000	0.006	0.000
B	6.800	6.300	0.268	0.248
C	0.580	0.350	0.023	0.014
C1	0.550	0.380	0.022	0.015
D	5.500	5.100	0.217	0.201
E	2.390	2.000	0.094	0.079
F	0.940	0.600	0.037	0.024
F1	0.860	0.500	0.034	0.020
L	10.400	9.400	0.409	0.370
L1	3.000	2.400	0.118	0.094
L2	6.200	5.300	0.244	0.209
L3	1.200	0.600	0.047	0.024
θ	9°	3°	9°	3°